



100V 3.0mΩ N-Ch Power MOSFET

Features

- Ultra-low $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100% R_g Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant

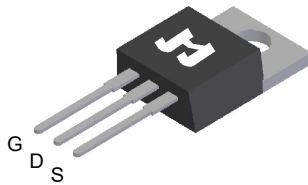
Product Summary

| Parameter | Typ. | Unit |
|--|------|------|
| V_{DS} | 100 | V |
| $V_{GS(th)}$ | 2.7 | V |
| I_D (@ $V_{GS} = 10V$) ⁽¹⁾ | 190 | A |
| $R_{DS(ON)}$ (@ $V_{GS} = 10V$) | 3.0 | mΩ |

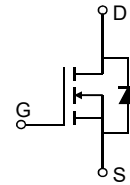
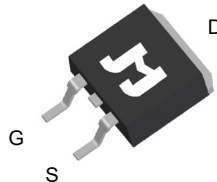
Applications

- Power Management in Telecom., Industrial Automation, CE
- Current Switching in DC/DC & AC/DC (SR) Sub-systems
- Motor Driving in Power Tool, E-vehicle, Robotics

TO-220-3L Top View



TO-263-3L Top View

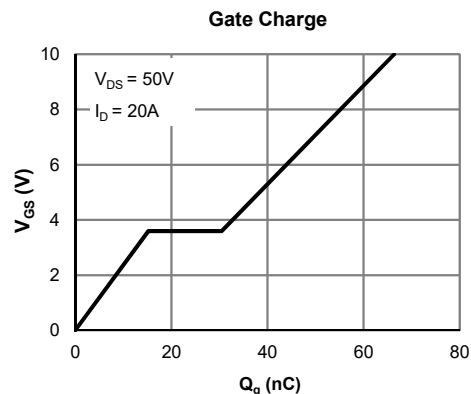
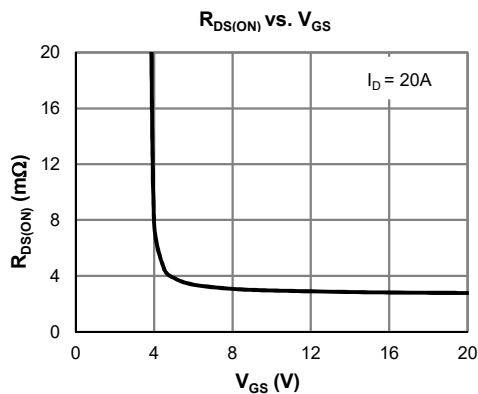


Ordering Information

| Device | Package | # of Pins | Marking | MSL | T_J (°C) | Media | Quantity (pcs) |
|---------------|-----------|-----------|---------|-----|------------|--------------|----------------|
| JMSH1004AC-U | TO-220-3L | 3 | SH1004A | N/A | -55 to 175 | Tube | 50 |
| JMSH1004AE-13 | TO-263-3L | 3 | SH1004A | 1 | -55 to 175 | 13-inch Reel | 800 |

Absolute Maximum Ratings (@ $T_A = 25^\circ C$ unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|---|----------------|---------------------|------|
| Drain-to-Source Voltage | V_{DS} | 100 | V |
| Gate-to-Source Voltage | V_{GS} | ±20 | V |
| Continuous Drain Current ⁽¹⁾ | I_D | $T_C = 25^\circ C$ | 190 |
| | | $T_C = 100^\circ C$ | 134 |
| Pulsed Drain Current ⁽²⁾ | I_{DM} | 531 | A |
| Avalanche Current ⁽³⁾ | I_{AS} | 70 | A |
| Avalanche Energy ⁽³⁾ | E_{AS} | 245 | mJ |
| Power Dissipation ⁽⁴⁾ | P_D | $T_C = 25^\circ C$ | 250 |
| | | $T_C = 100^\circ C$ | 125 |
| Junction & Storage Temperature Range | T_J, T_{STG} | -55 to 175 | °C |





Electrical Characteristics (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|---------------|--|---|------|-----------|---------------|
| STATIC PARAMETERS | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$ | 100 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 80\text{V}, V_{GS} = 0\text{V}$ | | | 1.0 | μA |
| | | | | | 5.0 | |
| Gate-Body Leakage Current | I_{GSS} | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$ | | | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 2.0 | 2.7 | 4.0 | V |
| Static Drain-Source ON-Resistance | $R_{DS(ON)}$ | $V_{GS} = 10\text{V}, I_D = 20\text{A}$ | | 3.0 | 3.6 | m Ω |
| Forward Transconductance | g_{FS} | $V_{DS} = 5\text{V}, I_D = 20\text{A}$ | | 85 | | S |
| Diode Forward Voltage | V_{SD} | $I_S = 1\text{A}, V_{GS} = 0\text{V}$ | | 0.71 | 1.0 | V |
| Diode Continuous Current | I_S | $T_C = 25^\circ\text{C}$ | | | 250 | A |
| DYNAMIC PARAMETERS ⁽⁵⁾ | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0\text{V}, V_{DS} = 50\text{V}, f = 1\text{MHz}$ | | 4398 | | pF |
| Output Capacitance | C_{oss} | | | 1361 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 8.5 | | pF |
| Gate Resistance | R_g | $V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$ | | 2.5 | | Ω |
| SWITCHING PARAMETERS ⁽⁵⁾ | | | | | | |
| Total Gate Charge (@ $V_{GS} = 10\text{V}$) | Q_g | $V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 50\text{V}, I_D = 20\text{A}$ | | 66 | | nC |
| Total Gate Charge (@ $V_{GS} = 6.0\text{V}$) | Q_g | | | 44 | | nC |
| Gate Source Charge | Q_{gs} | | | 15.2 | | nC |
| Gate Drain Charge | Q_{gd} | | | 15.2 | | nC |
| Turn-On Delay Time | $t_{D(on)}$ | $V_{GS} = 10\text{V}, V_{DS} = 50\text{V}$ $R_L = 2.5\Omega, R_{GEN} = 6\Omega$ | | 17.2 | | ns |
| Turn-On Rise Time | t_r | | | 37 | | ns |
| Turn-Off Delay Time | $t_{D(off)}$ | | | 68 | | ns |
| Turn-Off Fall Time | t_f | | | 61 | | ns |
| Body Diode Reverse Recovery Time | t_{rr} | | $I_F = 20\text{A}, di_F/dt = 100\text{A}/\mu\text{s}$ | | 94 | |
| Body Diode Reverse Recovery Charge | Q_{rr} | $I_F = 20\text{A}, di_F/dt = 100\text{A}/\mu\text{s}$ | | 242 | | nC |

Thermal Performance

| Parameter | Symbol | Typ. | Max. | Unit |
|---|-----------------|------|------|---------------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 45 | 55 | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 0.40 | 0.60 | $^\circ\text{C}/\text{W}$ |

Notes:

1. Computed continuous current assumes the condition of T_{J_Max} while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under $T_{J_Max} = 175^\circ\text{C}$.
3. This single-pulse measurement was taken under the following condition [$L = 100\mu\text{H}, V_{GS} = 10\text{V}, V_{DS} = 50\text{V}$] while its value is limited by $T_{J_Max} = 175^\circ\text{C}$.
4. The power dissipation P_D is based on $T_{J_Max} = 175^\circ\text{C}$.
5. This value is guaranteed by design hence it is not included in the production test.

Typical Electrical & Thermal Characteristics

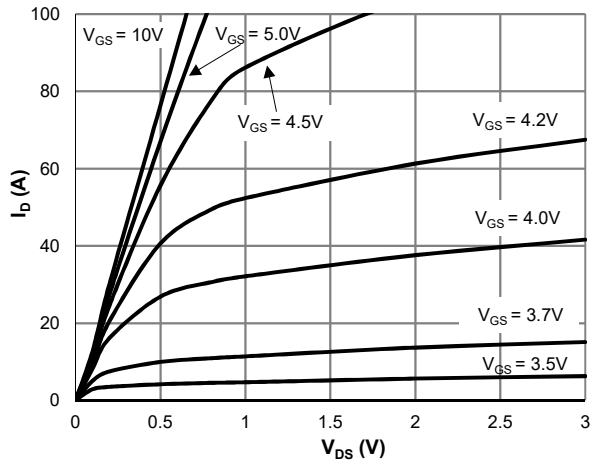


Figure 1: Saturation Characteristics

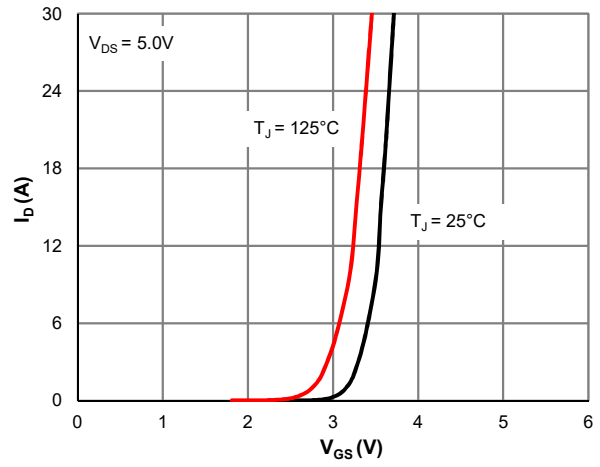


Figure 2: Transfer Characteristics

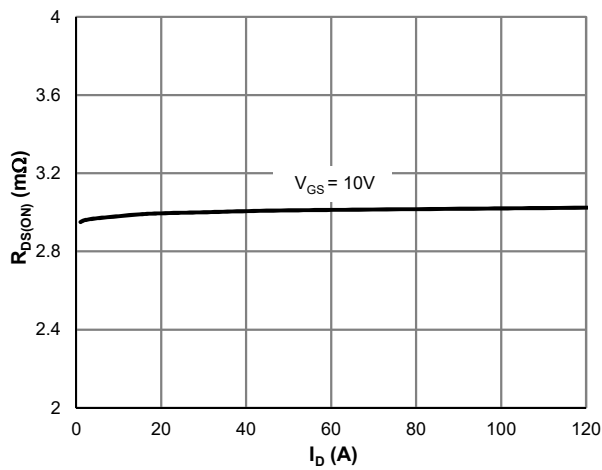


Figure 3: $R_{DS(ON)}$ vs. Drain Current

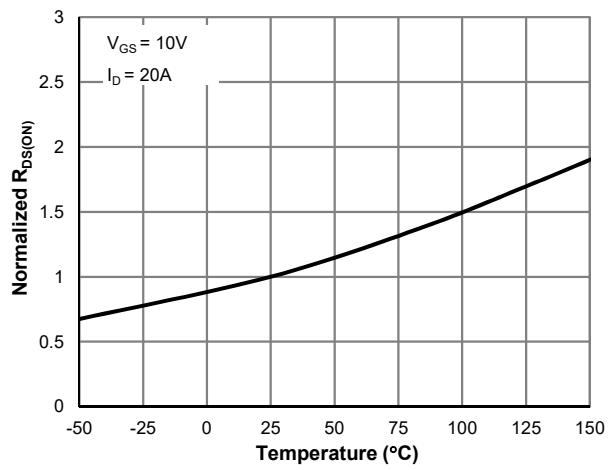


Figure 4: $R_{DS(ON)}$ vs. Junction Temperature

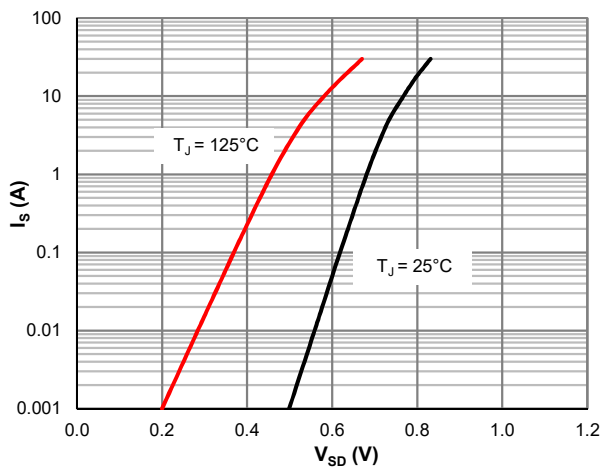


Figure 5: Body-Diode Characteristics

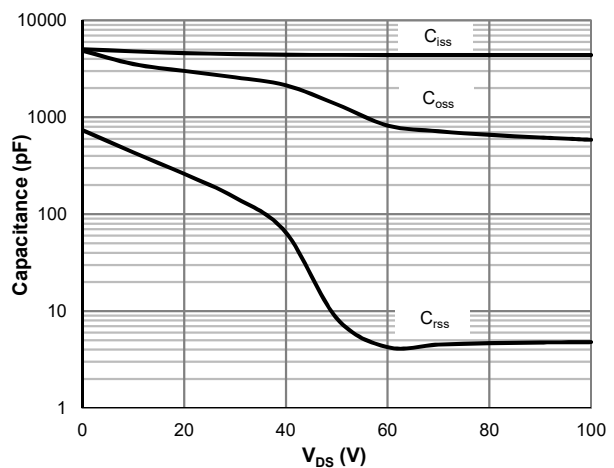


Figure 6: Capacitance Characteristics

Typical Electrical & Thermal Characteristics

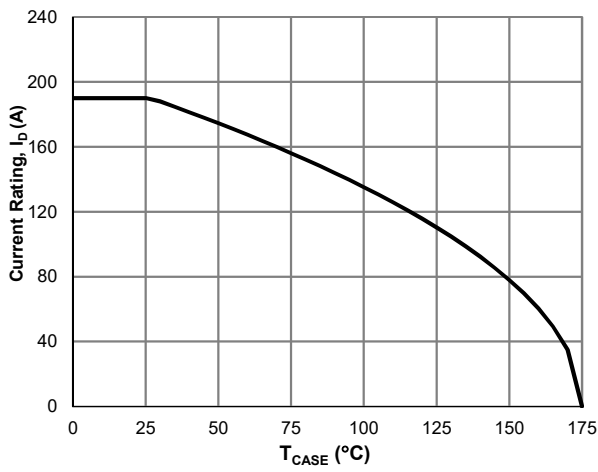


Figure 7: Current De-rating

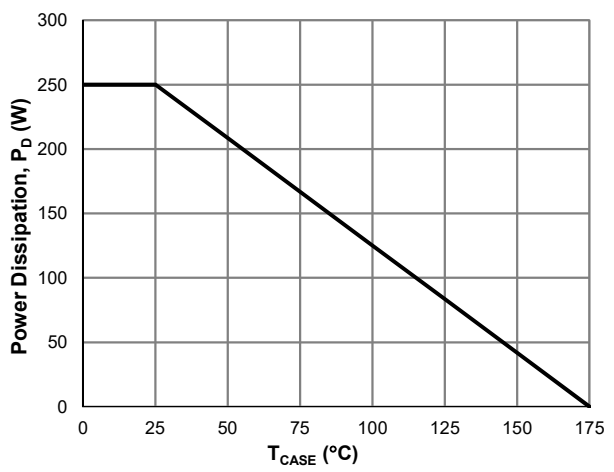


Figure 8: Power De-rating

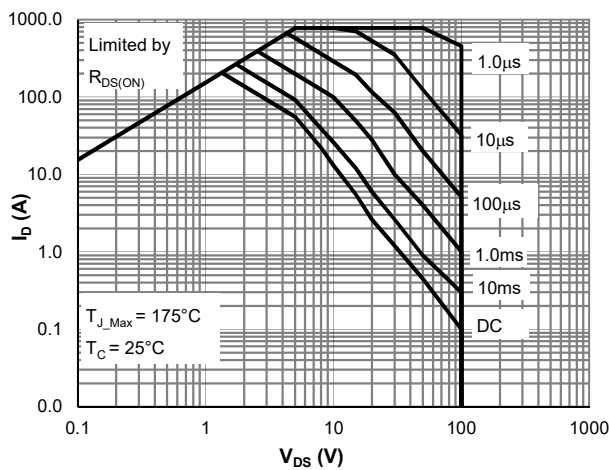


Figure 9: Maximum Safe Operating

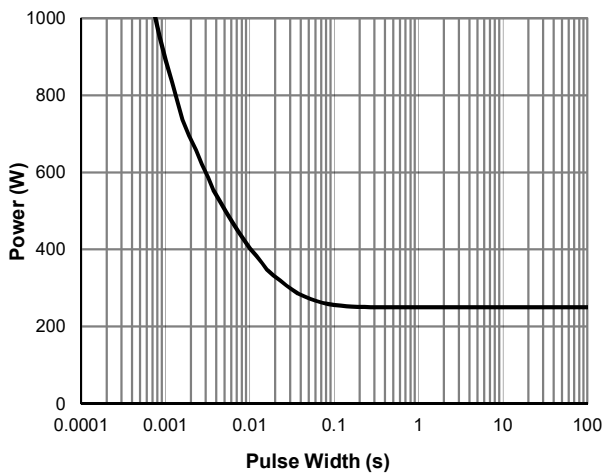


Figure 10: Single Pulse Power Rating, Junction-to-Case

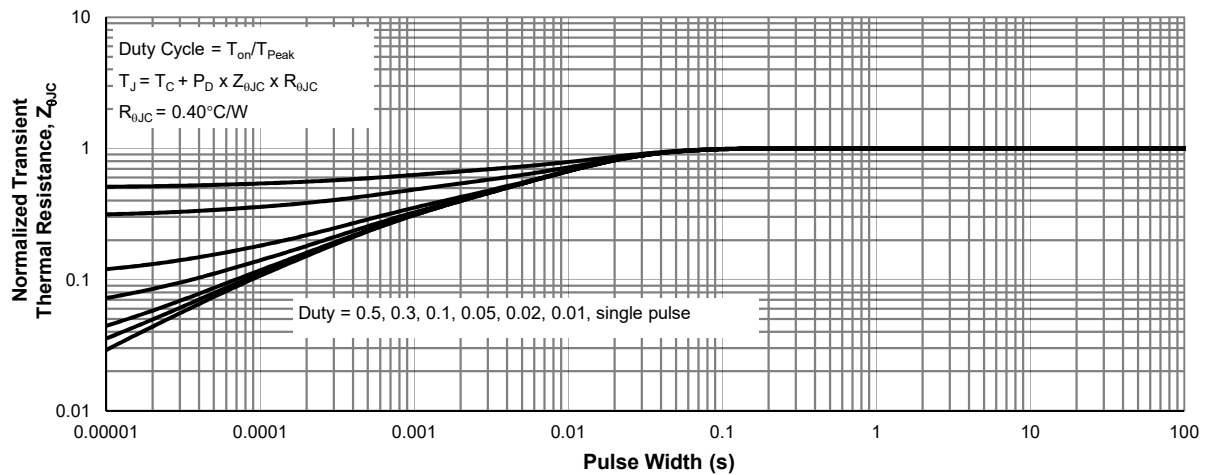
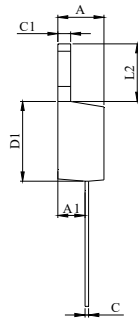
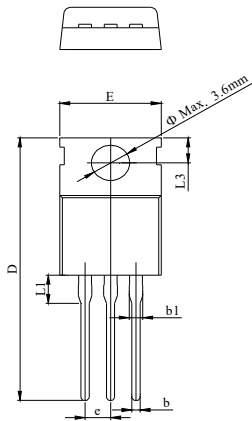


Figure 11: Normalized Maximum Transient Thermal Impedance

TO-220-3L Package Information

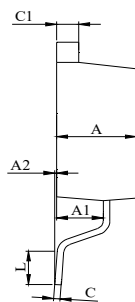
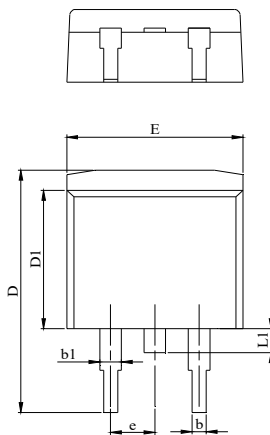
Package Outline



| DIM. | MILLIMETER | | |
|------|------------|----------|-------|
| | MIN. | NOM. | MAX. |
| A | 4.24 | | 4.70 |
| A1 | 2.20 | | 3.00 |
| b | 0.70 | | 0.95 |
| b1 | 1.14 | | 1.70 |
| C | 0.40 | | 0.60 |
| C1 | 1.15 | | 1.40 |
| D | 28.00 | | 29.80 |
| D1 | 8.80 | | 9.90 |
| E | 9.70 | | 10.50 |
| L1 | | | 3.80 |
| L2 | 6.25 | | 6.90 |
| L3 | 2.40 | | 3.00 |
| e | | 2.54 BSC | |

TO-263-3L Package Information

Package Outline



| DIM. | MILLIMETER | | |
|------|------------|------|-------|
| | MIN. | NOM. | MAX. |
| A | 4.24 | | 4.77 |
| A1 | 2.30 | | 2.89 |
| A2 | 0.00 | 0.10 | 0.25 |
| b | 0.70 | | 0.96 |
| b1 | 1.17 | | 1.70 |
| C | 0.30 | | 0.60 |
| C1 | 1.15 | | 1.42 |
| D | 14.10 | | 15.88 |
| D1 | 8.50 | | 9.60 |
| E | 9.78 | | 10.36 |
| L | 1.78 | | 2.79 |
| L1 | | | 1.75 |
| e | | 2.54 | |

Recommended Footprint

